

ML12034 2.0 GHz Dual Modulus Prescaler

MECL PLL COMPONENTS ÷32/33, ÷64/65 DUAL MODULUS PRESCALER SEMICONDUCTOR TECHNICAL DATA

Legacy Device: Motorola MC12034A

The ML12034 can be used with CMOS synthesizers requiring positive edges to trigger internal counters such as Motorola's MC145xxx series or Lansdale's ML145xxx series in a PLL to provide tuning signals up to 2.0 GHz in programmable frequency steps.

A Divide Ratio Control (SW) permits selection of a 32/33 or 64/65 divide ratio as desired.

The Modulus Control (MC) selects the proper divide number after SW has been biased to select the desired divide ratio.

- 2.0 GHz Toggle Frequency
- Supply Voltage 4.5 to 5.5 V
- ML12034 for Positive Edge Triggered Synthesizers
- 12mA Maximum, -40 to 85° C, $V_{CC} = 5.5$ Vdc
- Modulus Control Input is Compatible with Standard CMOS and TTL
- Low–Supply Current 8.5 mA Typical
- Operating Temperature Range $T_A = -40$ to 85° C

FUNCTIONAL TABLE

sw	МС	Divide Ratio
Н	Н	32
Н	L	33
L	Н	64
L	L	65

NOTES: 1. SW: H = V_{CC}, L = Open. A logic L can also be applied by grounding this pin, but this is not recommended due to increased power consumption.

2. MC: H = 2.0 V to V_{CC}, L = Gnd to 0.8 V.

Design Criteria	Value	Unit	
Internal Gate Count *	67	ea	
Internal Gate Propagation Delay	200	ps	
Internal Gate Power Dissipation	issipation 0.75 m\		
Speed Power Product	0.15	рJ	

NOTE: *Equivalent to a two-input NAND gate.

MAXIMUM RATINGS

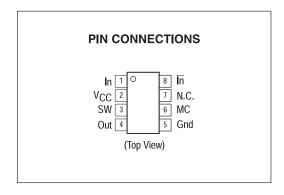
Characteristic	Symbol	Range	Unit
Power Supply Voltage, Pin 2	Vcc	-0.5 to 7.0	Vdc
Operating Temperature Range	TA	-40 to 85	°C
Storage Temperature Range	T _{stg}	-65 to 150	°C
Modulus Control Input, Pin 6	МС	-0.5 to 6.5	Vdc

NOTES: 1. ESD data available upon request.

2. This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range Gnd \leq (V_{in} or V_{out}) \leq V_{CC} .

P DIP 8 = PP PLASTIC PACKAGE CASE 626-04 SO 8 = -5PPLASTIC PACKAGE **CASE 751** (SO-8)**CROSS REFERENCE/ORDERING INFORMATION** PACKAGE **MOTOROLA** LANSDALE MC12034AP ML12034PP P-DIP 8 MC12034AD ML12034-5P **SO8**

Note: Lansdale lead free (**Pb**) product, as it becomes available, will be identified by a part number prefix change from **ML** to **MLE**.



ELECTRICAL CHARACTERISTICS ($V_{CC} = 4.5 \text{ to } 5.5 \text{ Vdc}$, $T_A = -40 \text{ to } 85^{\circ}\text{C}$, unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
Toggle Frequency (Sine Wave)	f _t	0.5	2.4	2.0	GHz
Supply Current Output Unloaded (Pin 2)	Icc	-	8.5	12	mA
Modulus Control Input High (MC)	V _{IH1}	2.0	_	VCC	V
Modulus Control Input Low (MC)	V _{IL1}	_	-	0.8	V
Divide Ratio Control Input High (SW)	V _{IH2}	VCC	VCC	VCC	Vdc
Divide Ratio Control Input Low (SW)	V _{IL2}	Open	Open	Open	_
Output Voltage Swing (C _L = 12 pF, R _L = 1.1 k Ω)	V _{out}	1.0	1.6	_	V _{pp}
Modulus Setup Time MC to Out	^t SET	_	8.0	10.0	ns
Input Voltage Sensitivity 500 to 2000 MHz	V _{in}	100	_	1500	mVpp
Output Current (C _L = 12 pF, R _L = 1.1 k Ω)	I _O	_	_	3.5	mA

Figure 1. Logic Diagram

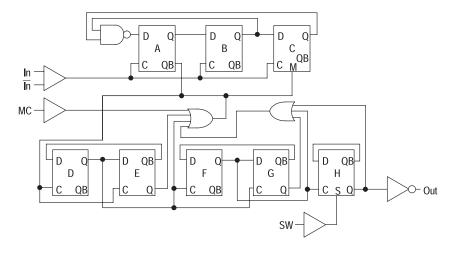
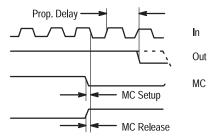


Figure 2. Modulus Setup Time



Modulus setup time MC to out is the MC setup or MC release plus the prop. delay.

Figure 3. Typical Output Waveform

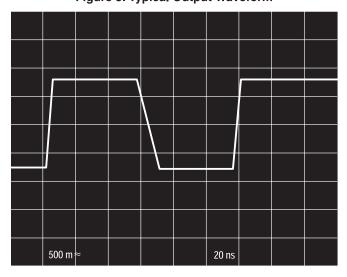


Figure 4. AC Test Circuit

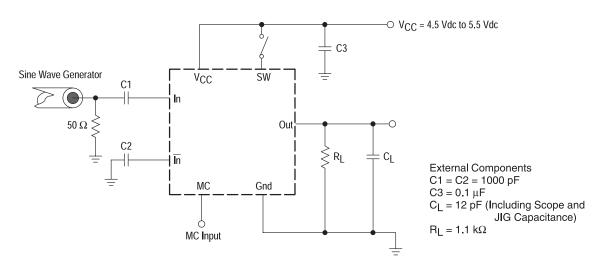


Figure 5. Input Signal Amplitude versus Input Frequency

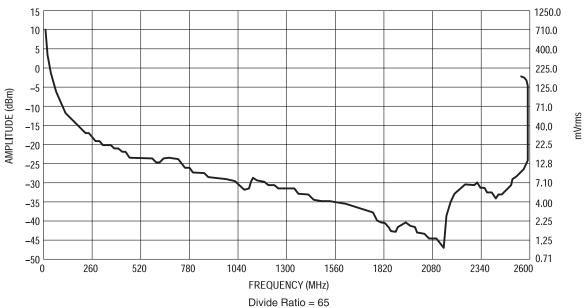


Figure 6. Output Amplitude versus Input Frequency

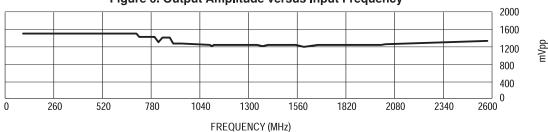


Figure 7. Generic block diagram showing prescaler connection to PLL device

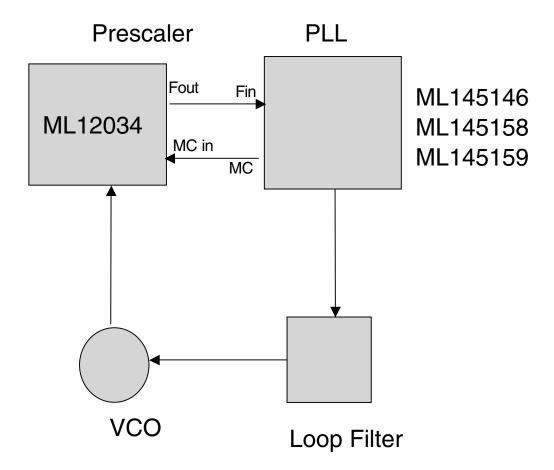
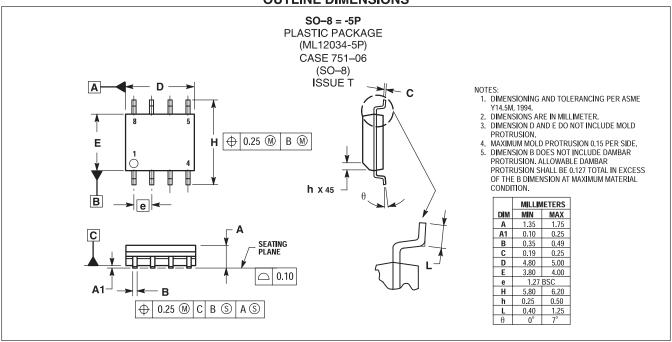
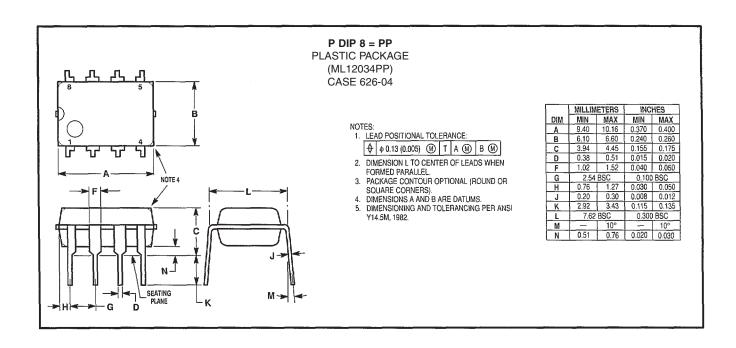


Figure 7 shows a generic block diagram of connecting a prescaler to a PLL device that supports dual modulus control. Application note AN535 decribes using a two-modulus prescaler technique. By using prescaler higher frequencies can be achieve than by a single CMOS PLL device.

OUTLINE DIMENSIONS





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